

UTILITY PATENT APPLICATION UNDER 37 CFR 1.53(b)



Box PATENT APPLICATION Commissioner for Patents Washington, DC 20231

Case Docket No. 60188-063

Sir:

Transmitted herewith for filing is the patent application of:

INVENTOR: Bunji MIZUNO, Hiroaki NAKAOKA, Michihiko TAKASE, Ichiro

NAKAYAMA

FOR: METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE

ed are:
80 pages of specification, claims, abstract.
Declaration and Power of Attorney.
Priority Claimed.
Certified copy of
10 sheets of formal drawing.
An assignment of the invention to
and the assignment recordation fee.
An associate power of attorney.
Information Disclosure Statement. Form PTO-1449 and reference.
Return Receipt Postcard
Preliminary Amendment

Respectfully submitted.

MCDERMOTŢ, WILL & EMERY

Michael E. Fogarty

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Facsimile: (202) 756-8087

20277

PATENT TRADEMARK OFFICE

Docket No.: 60188-063 PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Bunji MIZUNO, et al.

Serial No.:

Group Art Unit:

Filed: April 24, 2001

Examiner:

For:

METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE

CLAIM OF PRIORITY

Assistant Commissioner for Patents Washington, DC 20231

Sir:

In accordance with the provisions of 35 U.S.C. 120, Applicants hereby claim the priority of U. S. Patent Application No. 09/178.766, filed October 26, 1998, of which this application is a Continuation-In-Part, which is a divisional of U.S. Patent Application No. 08/734,218, filed October 21, 1996, which claims the benefit of the priority under 35 U.S.C. 119 of:

Japanese Patent Application No. 7-274234, filed October 23, 1995

• The certified copy was filed in U.S. Patent Application Serial No. 08/734.218 in support of the claim of priority. Acknowledgement is respectfully requested.

Respectfully submitted.

MCDERMOTT, WILL & EMERY

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